



JT010N065SED/CED/FED/WED

主要参数 MAIN CHARACTERISTICS

I_c	10 A
V_{CES}	650V
$V_{CESAT-TYP}$	1.5V

用途

- 逆变器
- UPS 电源
- 电机控制

产品特性

- 低栅极电荷
- Trench FS 技术
- RoHS 产品

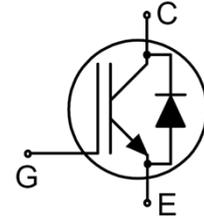
APPLICATIONS

- General purpose inverters
- UPS
- Motor Control

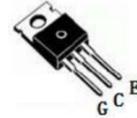
FEATURES

- Low gate charge
- Trench FS Technology
- RoHS product

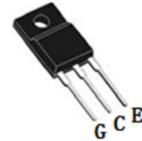
封装 Package



TO-263



TO-220C



TO-220MF



TO-247

订货信息 ORDER MESSAGE

订货型号 Order codes		印 记 Marking	封 装 Package
无卤-条管 None Halogen-Tube	无卤-编带 Halogen-Free-Reel		
JT010N065SED-S-BR	JT010N065SED-S-AR	JT010N065SED	TO-263
JT010N065CED-C-BR	N/A	JT010N065CED	TO-220C
JT010N065FED-F-BR	N/A	JT010N065FED	TO-220MF
JT010N065WED-GE-BR	N/A	JT010N065WED	TO-247



绝对最大额定值 ABSOLUTE RATINGS (Tc=25°C)

项 目 Parameter	符 号 Symbol	数 值 Value			单 位 Unit
		JT010N065SED/ JT010N065CED	JT010N065FED	JT010N065WED	
最高集电极-发射极直流电压 Collector-emitter voltage	V _{CES}	650	650	650	V
*连续集电极电流 Collector current- continuous	I _C	20 (T _C =25°C)	20 (T _C =25°C)	20 (T _C =25°C)	A
		10(T _C =100°C)	10(T _C =100°C)	10(T _C =100°C)	A
最大脉冲集电极极电流 (注 1) Collector current – pulse (note 1)	I _{CM}	40	40	40	A
二极管正向测试电流 Diode RMS forward current	I _F	20(T _C =25°C)	20(T _C =25°C)	20(T _C =25°C)	A
	I _F	10(T _C =100°C)	10(T _C =100°C)	10(T _C =100°C)	A
二极管正向不重复峰值电流 (浪涌电流) Surge non repetitive forward current tp= 10 ms sinusoidal	I _{FSM}	40	40	40	A
最高栅极发射极电压 Gate-emitter voltage	V _{GE}	±30	±30	±30	V
安全工作区 Turn-off safe area	-	40	40	40	A
耗散功率 Power dissipation	P _D T _C =25°C	136	37	166	W
存储温度 Storage temperature range	T _{STG}	-55~+150	-55~+150	-55~+150	°C
结温 Junction temperature range	T _{VJ}	-55~+175	-55~+175	-55~+175	°C
引线最高焊接温度 Maximum lead temperature for soldering purposes	T _L	300	300	300	°C

*连续集电极电流由最高结温限制。*Collector current limited by maximum Junction temperature.

注 1: 脉冲宽度由最高结温限制。 Note1: The pulse width is limited by the maximum junction temperature.





电特性 ELECTRICAL CHARACTERISTICS

项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
关态特性 Off –Characteristics						
集电极-发射极击穿电压 Collector-emitter voltage	BV_{CES}	$I_C=500\mu A, V_{GE}=0V$	650	-	-	V
击穿电压温度特性 Breakdown voltage temperature coefficient	$\Delta BV_{CES}/\Delta T_J$	$I_C=1mA$, referenced to $25^\circ C$	-	0.5	-	$V/^\circ C$
零栅压下集电极漏电流 Zero gate voltage collector current	I_{CES}	$V_{CE}=650V, V_{GE}=0V,$ $T_C=25^\circ C$	-	-	10	μA
		$V_{CE}=650V, V_{GE}=0V,$ $T_C=175^\circ C$	-	-	2	mA
正向栅极体漏电流 Gate-body leakage current, forward	I_{GESF}	$V_{CE}=0V, V_{GE}=20V$	-	-	200	nA
反向栅极体漏电流 Gate-body leakage current, reverse	I_{GESR}	$V_{CE}=0V, V_{GE}=-20V$	-	-	-200	nA
通态特性 On-Characteristics						
阈值电压 Gate threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}, I_C=250\mu A$ $T_C=25^\circ C$	5.5	6	6.5	V
饱和压降 Collector-emitter saturation voltage	V_{CESAT}	$V_{GE}=15V, I_C=10A,$ $T_C=25^\circ C$	-	1.5	1.9	V
		$V_{GE}=15V, I_C=10A,$ $T_C=125^\circ C$	-	1.65	2.05	V
		$V_{GE}=15V, I_C=10A,$ $T_C=175^\circ C$	-	1.8	2.2	V
动态特性 Dynamic Characteristics						
输入电容 Input capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V,$ $f=1.0MHz, T_C=25^\circ C$	-	800	-	pF
输出电容 Output capacitance	C_{oes}		-	60	-	pF
反向传输电容 Reverse transfer capacitance	C_{res}		-	17	-	pF
栅极电荷总量 Total gate charge	Q_g	$V_{CC}=400V, I_C=10A, R_G=1$ $0\Omega, V_{GE}=15V, T_C=25^\circ C$	-	27.4	-	nC
栅极-发射极 Gate to emitter charge	Q_{ge}		-	6.5	-	
栅极-集电极 Gate to collector charge	Q_{gc}		-	11.9	-	
栅极电阻-Gate resistance	R_g	$f=1MHz, \text{open collector}$	-	2.1	-	Ω
短路电流-Short current	I_{sc}	$V_{GE}=15V, V_{CE}=360V,$ $T_{Jstart} \leq 175^\circ C, t_{sc} \leq 10\mu s$	-	58	-	A





电特性 ELECTRICAL CHARACTERISTICS

开关特性 Switching Characteristics						
项 目 Parameter	符 号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units
开启延迟时间 Turn-on delay time	$t_{d(on)}$	$V_{CC}=400V, I_{CC}=10A,$ $R_G=10\Omega, V_{GE}=15V,$ $T_j=25^\circ C$	-	13	-	ns
上升时间 Turn-on rise time	t_r		-	20	-	ns
关断延迟时间 Turn-off delay time	$t_{d(off)}$		-	47	-	ns
下降时间 Turn-off fall time	t_f		-	60	-	ns
开通损耗 Turn-on energy	E_{on}		-	0.35	-	mJ
关断损耗 Turn-off energy	E_{off}		-	0.1	-	mJ
总开关损耗 Total switching energy	E_{tot}		-	0.45	-	mJ
开启延迟时间 Turn-on delay time	$t_{d(on)}$	$V_{CC}=400V, I_C=10A,$ $R_G=10\Omega, V_{GE}=15V,$ $T_j=175^\circ C$	-	16.0	-	ns
上升时间 Turn-on rise time	t_r		-	20.0	-	ns
关断延迟时间 Turn-off delay time	$t_{d(off)}$		-	68.0	-	ns
下降时间 Turn-off fall time	t_f		-	84.0	-	ns
开通损耗 Turn-on energy	E_{on}		-	0.35	-	mJ
关断损耗 Turn-off energy	E_{off}		-	0.17	-	mJ
总开关损耗 Total switching energy	E_{tot}		-	0.52	-	mJ
反并联二极管特性及最大额定值 Anti-Parallel Diode Characteristics and Maximum Ratings						
正向压降 Diode forward voltage	V_F	$V_{GE}=0V, I_F=10A, T_C=25^\circ C$	-	1.75	-	V
		$V_{GE}=0V, I_F=10A, T_C=125^\circ C$	-	1.45	-	V
		$V_{GE}=0V, I_F=10A, T_C=175^\circ C$	-	1.25	-	V
反向恢复时间 Diode reverse recovery time	T_{rr}	$T_j=25^\circ C, I_F=10A,$ $V_{GE}=0V, di/dt = 100A/us$	-	54.6	-	ns
反向恢复电荷 Diode reverse recovery charge	Q_{rr}		-	34.9	-	nC
反向恢复电流 Diode reverse recovery current	I_{rrm}		-	1.13	-	A
反向恢复时间 Diode reverse recovery time	T_{rr}	$T_j=175^\circ C, I_F=10A,$ $V_{GE}=0V, di/dt = 100A/us$	-	80.9	-	ns
反向恢复电荷 Diode reverse recovery charge	Q_{rr}		-	51.7	-	nC
反向恢复电流 Diode reverse recovery current	I_{rrm}		-	1.67	-	A



JT010N065SED CED FED WED

项目 Parameter	符号 Symbol	最大 (max)			单位 Unit
		JT010N065SED/ JT010N065CED	JT010N065FED	JT010N065WED	
结到管壳的热阻 (IGBT) Thermal resistance, junction to case	$R_{th(J-C)}$	1.1	3.1	0.9	°C/W
结到管壳的热阻 (FRD) Thermal resistance, junction to case	$R_{th(J-C)}$	2.2	4.9	2.1	°C/W
结到环境的热阻 Thermal resistance, junction to ambient	$R_{th(J-A)}$	62.5	62.5	40	°C/W

注释:

- 1: 脉冲宽度由最高结温限制
- 2: 基本与工作温度无关
- 3: 脉冲测试: 脉冲宽度 $\leq 300\mu s$, 占空比 $\leq 2\%$

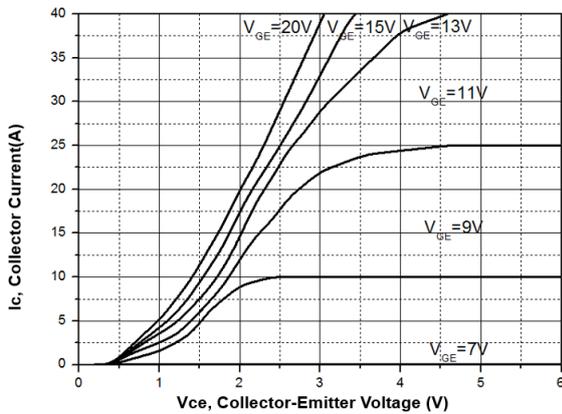
Notes:

- 1: Pulse width limited by maximum junction temperature
- 2: Essentially independent of operating temperature
- 3: Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

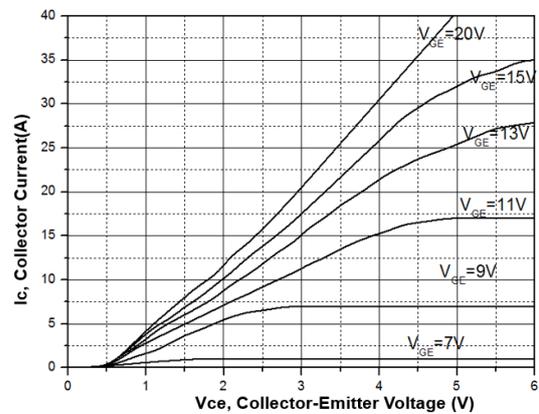


特征曲线 ELECTRICAL CHARACTERISTICS (curves)

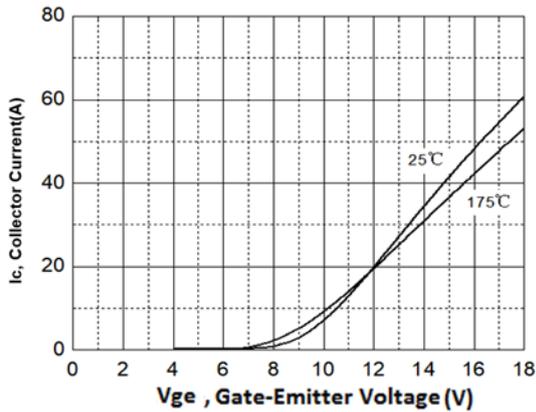
Output Characteristics $T_J=25^{\circ}\text{C}$



Output Characteristics $T_J=175^{\circ}\text{C}$

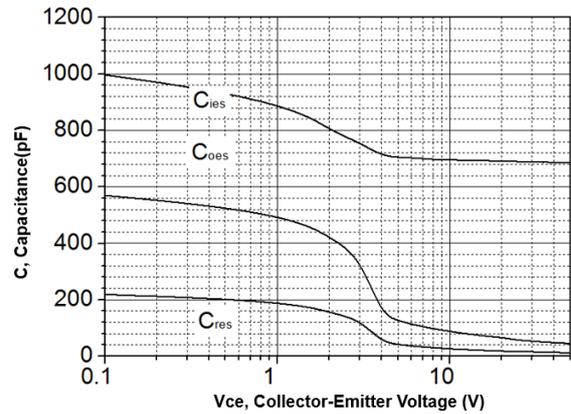


Typical Transfer Characteristics



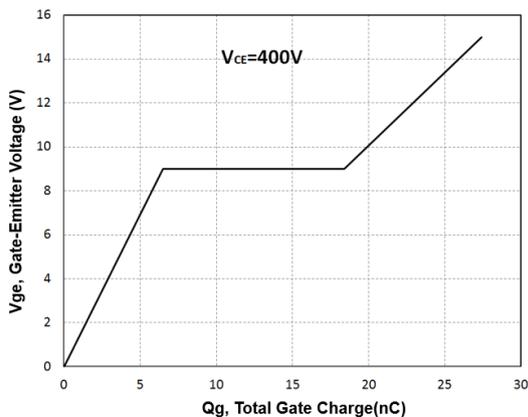
Capacitance Characteristics

$V_{GE}=0\text{V}, f=1.0\text{MHz}$

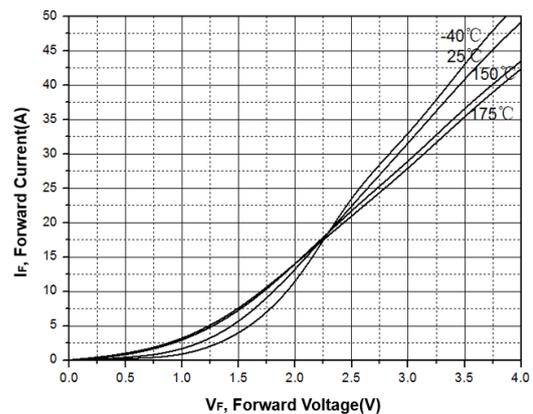


Gate Charge Characteristics

$V_{ce}=400\text{V}$

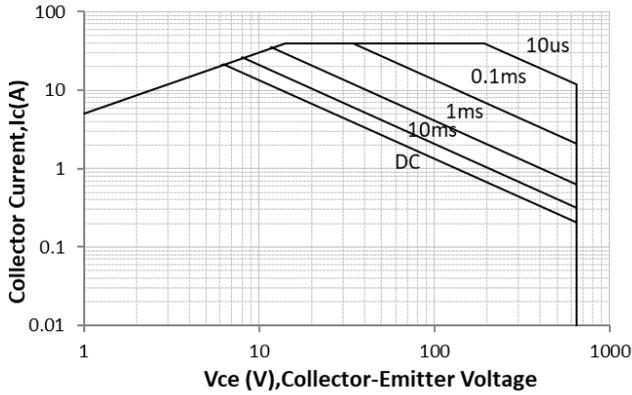


Diode Characteristic

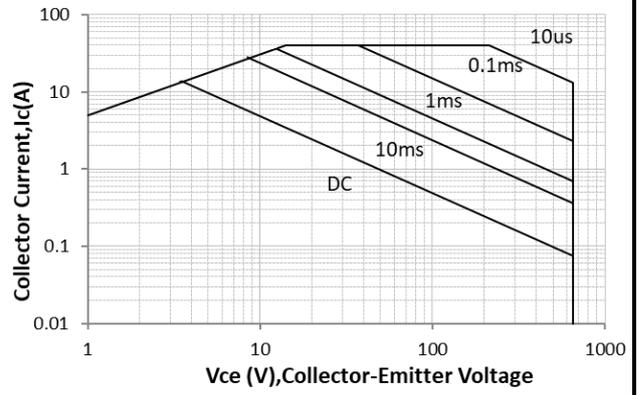




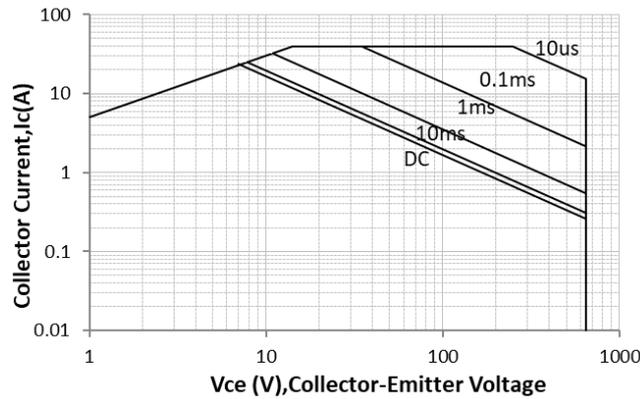
SOA Characteristics For TO-263/TO-220C



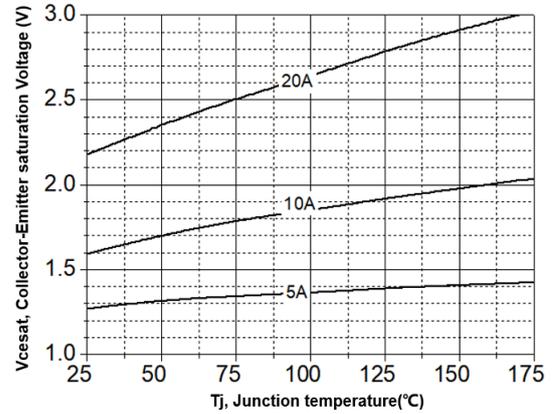
SOA Characteristics For TO-220MF



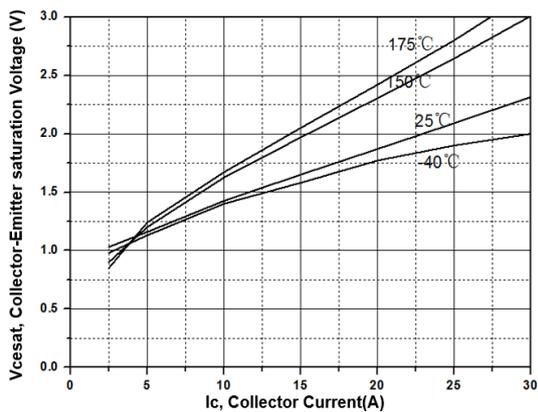
SOA Characteristics For TO-247



Vcesat vs Tj

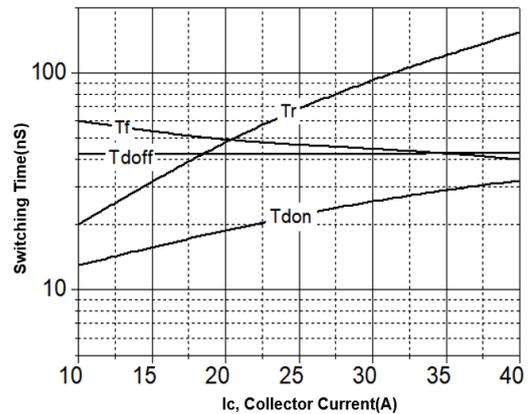


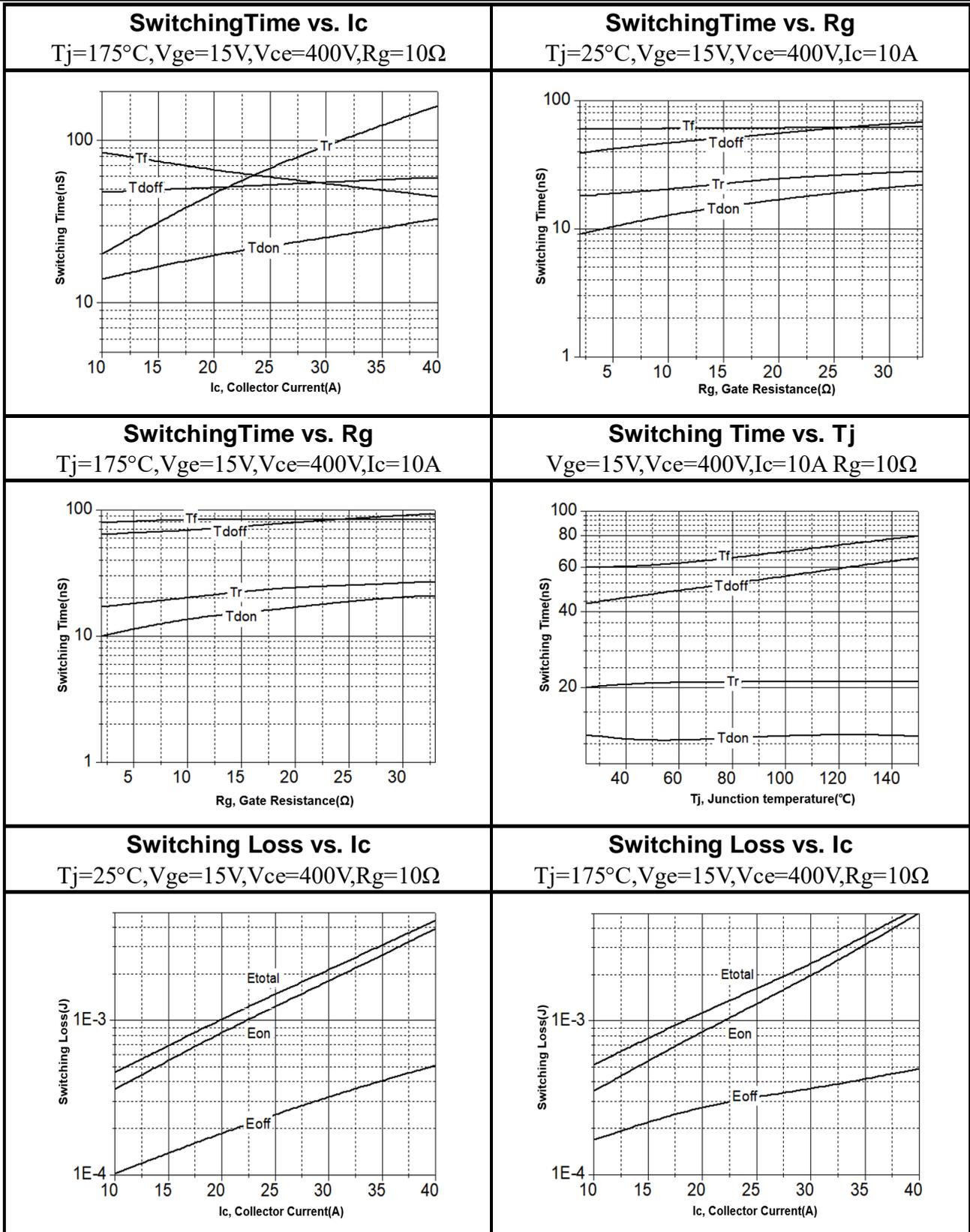
Vcesat vs Ic

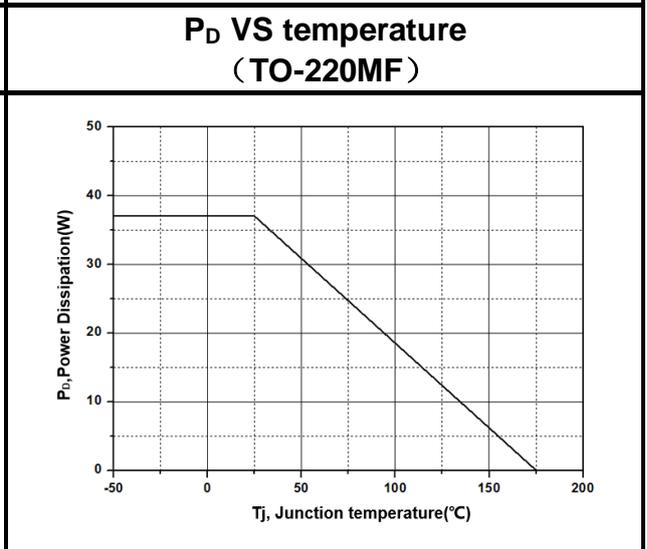
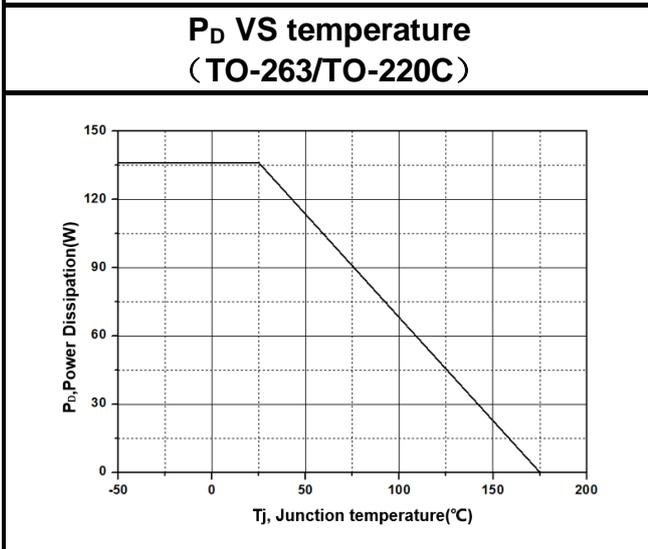
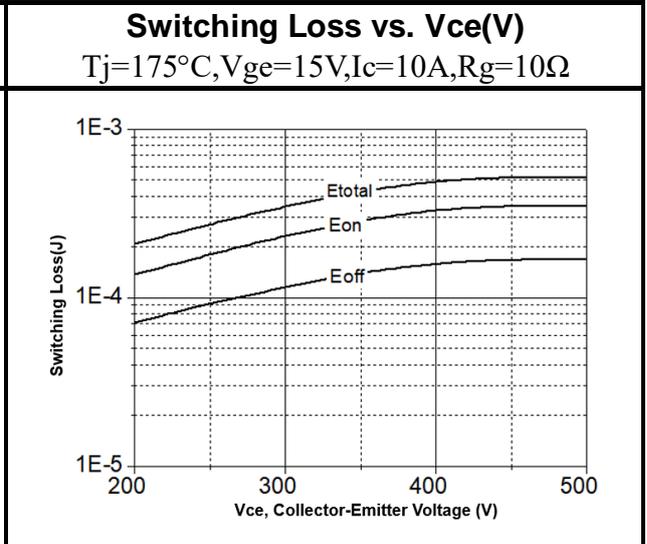
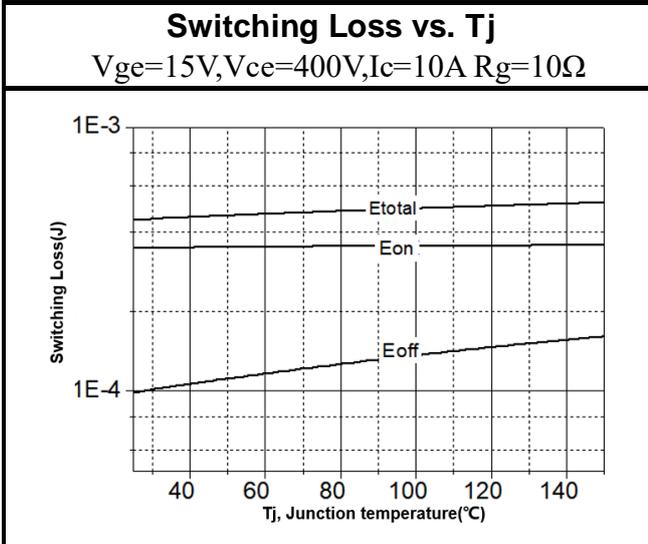
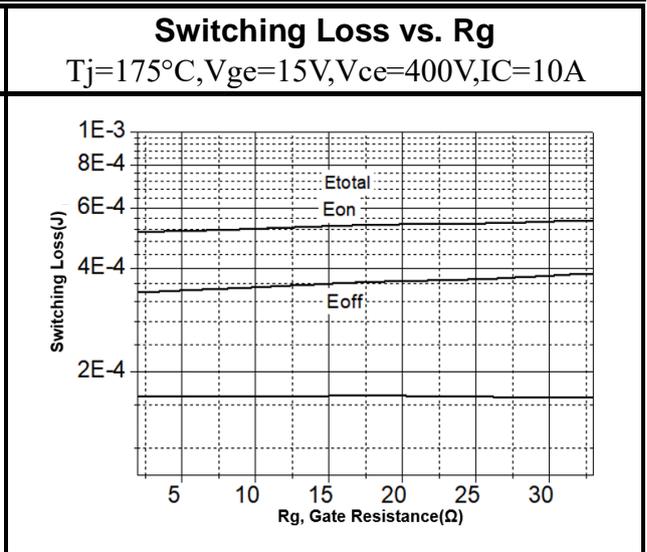
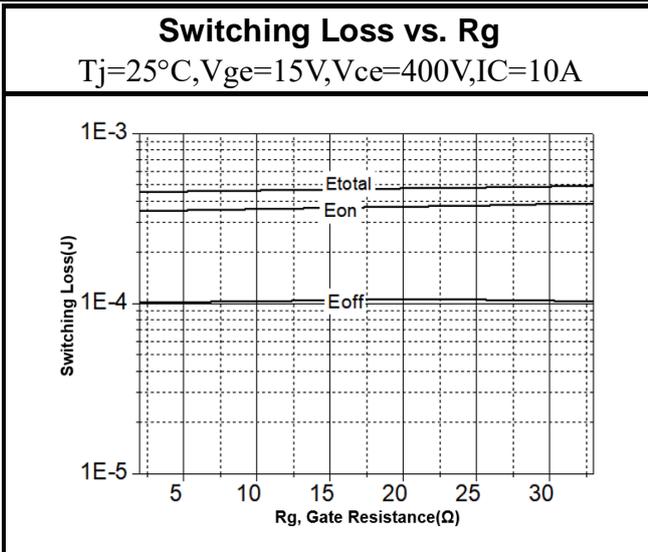


Switching Time vs Ic

$T_j=25^{\circ}$ C, $V_{ge}=15$ V, $V_{CE}=400$ V, $R_g=10\Omega$

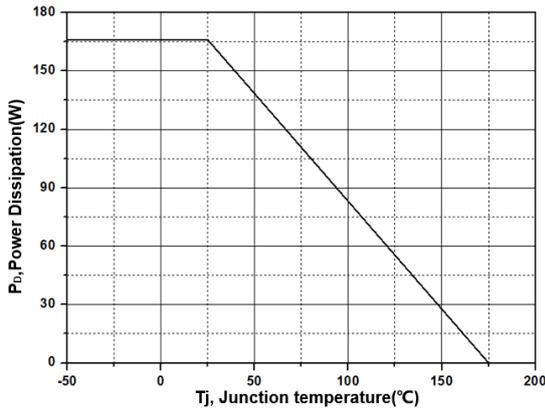




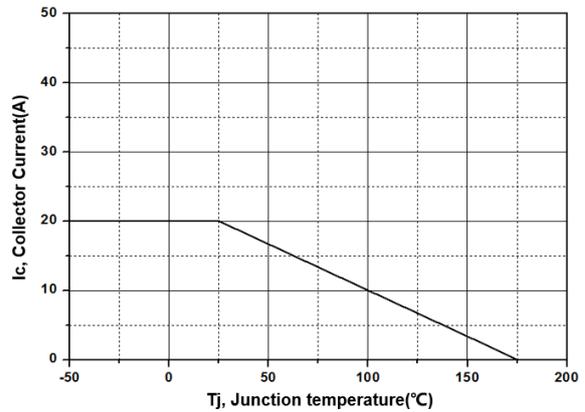




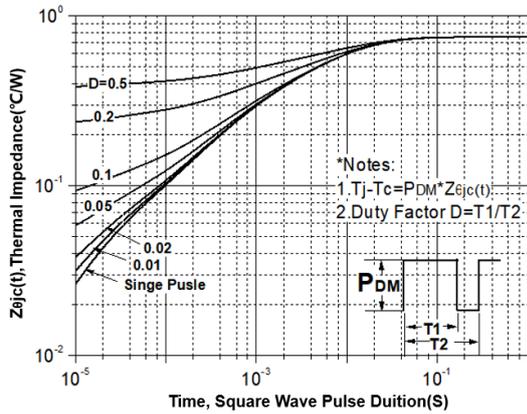
**P_D VS temperature
(TO-247)**



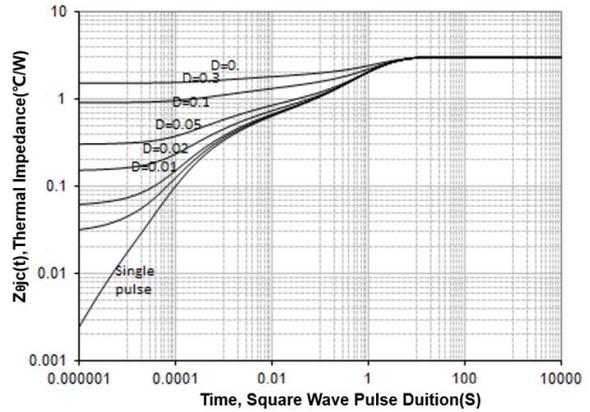
Ic VS temperature



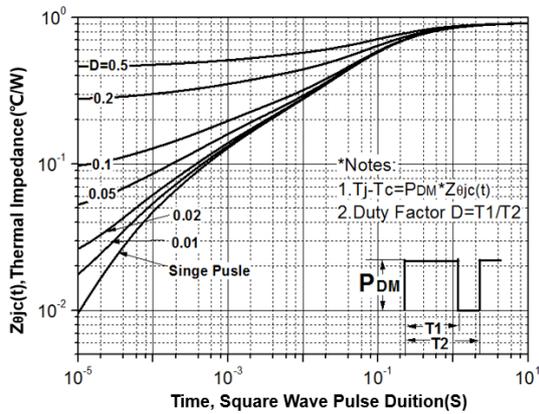
**Normalized Maximum Transient Thermal Impedance for IGBT
(TO-263/TO-220C)**



**Normalized Maximum Transient Thermal Impedance for IGBT
(TO-220MF)**



**Normalized Maximum Transient Thermal Impedance for IGBT
(TO-247)**

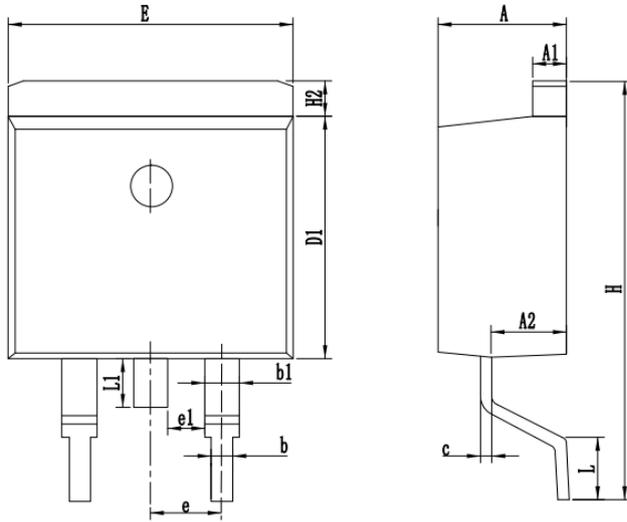




外形尺寸PACKAGE MECHANICAL DATA

TO-263

单位 UNIT : mm



SYMBOL	MM	
	MIN	MAX
A	4.30	4.80
A1	1.12	1.42
A2	2.54	2.84
b	0.67	1.00
b1	1.15	1.40
c	0.29	0.52
D1	8.40	9.00
E	9.80	10.46
e	2.54BSC	
e1	1.15	1.45
H	14.00	16.00
H2	1.12	1.45
L	1.50	3.10
L1	1.45	1.70

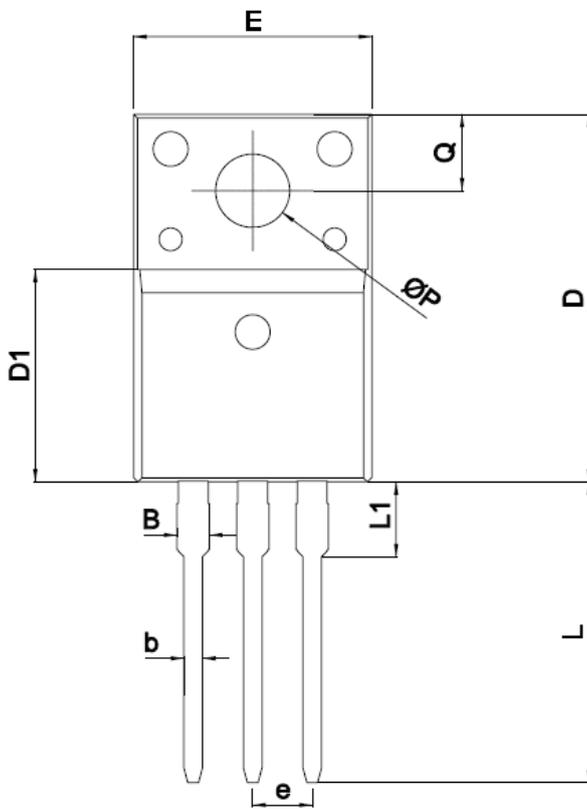




外形尺寸PACKAGE MECHANICAL DATA

TO-220MF

单位 Unit : mm



SYMBOL	mm	
	MIN	MAX
A	4.5	4.9
B		1.47
b	0.7	0.9
c	0.45	0.60
D	15.67	16.07
D1	9.04	9.20
e	2.54TYPE	
E	9.96	10.36
F	2.34	2.74
L	12.58	13.38
L1	3.13	3.33
Q	3.2	3.4
Q1	2.56	2.96
ΦP	3.08	3.28

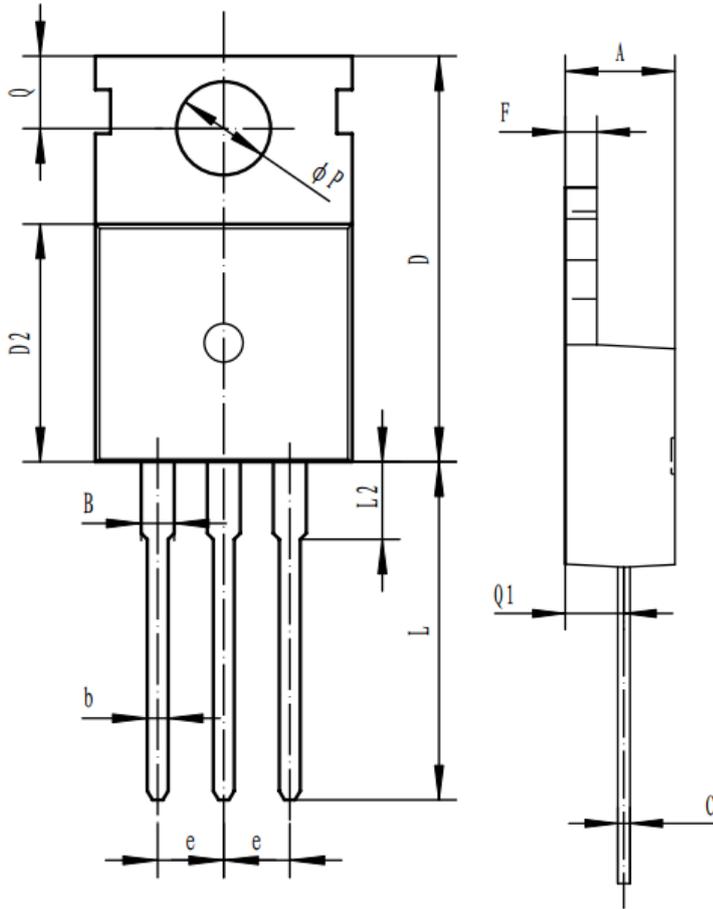




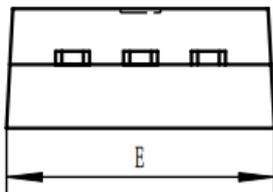
外形尺寸PACKAGE MECHANICAL DATA

TO-220C

单位 Unit : mm



符号 symbol	MIN	MAX
A	4.30	4.70
B	1.22	1.40
b	0.70	0.95
c	0.40	0.65
D	15.20	16.20
D2	9.00	9.40
E	9.70	10.10
e	2.39	2.69
F	1.25	1.40
L	12.60	13.60
L2	2.80	3.20
Q	2.60	3.00
Q1	2.20	2.60
P	3.50	3.80

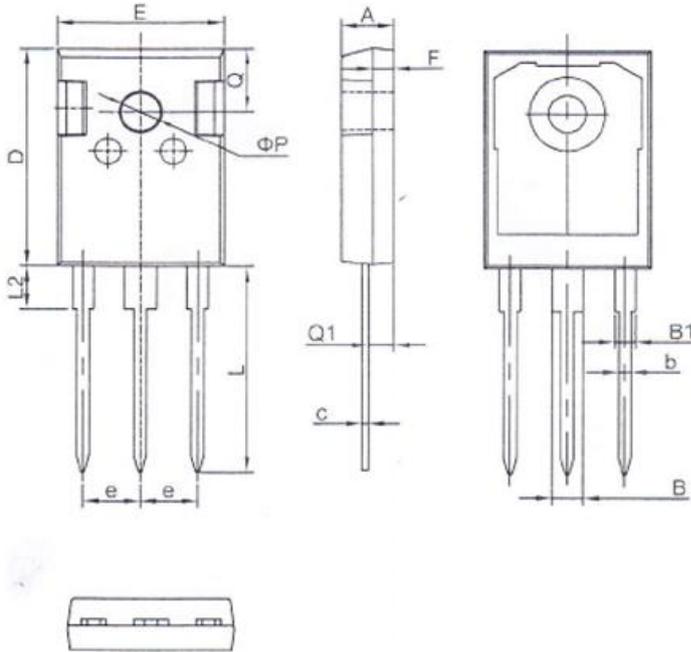




外形尺寸PACKAGE MECHANICAL DATA

TO-247

单位 Unit : mm



符号 symbol	MIN	MAX
A	4.90	5.10
B	2.95	3.35
B1	1.95	2.35
b	1.15	1.35
c	0.50	0.70
D	20.90	21.10
E	15.70	15.90
e	5.34	5.54
F	1.90	2.10
L	19.40	20.40
L2	4.03	4.23
Q	6.00	6.40
Q1	2.30	2.50
P	3.50	3.70



注意事项

1. 吉林华微电子股份有限公司的产品销售分为直销和销售代理，无论哪种方式，订货时请与公司核实。
2. 购买时请认清公司商标，如有疑问请与公司本部联系。
3. 在电路设计时请不要超过器件的绝对最大额定值，否则会影响整机的可靠性。
4. 本说明书如有版本变更不另外告知。

NOTE

1. Jilin Sino-microelectronics co., Ltd sales its product either through direct sales or sales agent , thus, for customers, when ordering , please check with our company.
2. We strongly recommend customers check carefully on the trademark when buying our product, if there is any question, please don't be hesitate to contact us.
3. Please do not exceed the absolute maximum ratings of the device when circuit designing.
4. Jilin Sino-microelectronics co., Ltd reserves the right to make changes in this. specification sheet and is subject to change without prior notice.

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